

STRUCTURE	Silicon Monolithic Integrated Circuit	
PRODUCT SERIES	BTL driver for CD/CD-ROM	
TYPE	BA 5 9 8 3 FP	
PACKAGE OUTLINES	Figure 1 (Plastic Mold)	
POWER DISSIPATION	Figure 2	
BLOCK DIAGRAM	Figure 3	
APPLICATION	Figure 4	,
TEST CIRCUIT	Figure 5	

#### FUNCTIONS

## • 4ch BTL Driver.

- Small surface mounting power package (HSOP 28).
- Wide dynamic range. (4V(typ.) at PreVcc=12V,PowVcc=5V,RL=8Ω)
- · Thermal shut down circuit built in.
- Separating Vcc into Pre and Power (Power divides into CH1/2 and CH3/4), can make better power efficiency, by low supply voltage drive.
- Mute operated individually CH4 and CH1/2/3.
- · All channels mute is stand by mode.
- Suitable for low operation voltage DSP by wide D-range pre opamp.

#### ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Limits	Unit
Supply voltage	PreVcc,PowVcc	13.5	V
Power dissipation	Pd	1.7 #1	W
Max output current	Iomax	1 # 2	Α
Operating temperature	Topr	-35~ 85	°C
Storage temperature	Tstg	-55~ 150	°C

#1 On less than 3% (percentage occupied by copper foi), 70x 70mm<sup>2</sup>, t=1.6mm, glass epoxy mounting. Reduce power by 13.6mW for each degree above 25°C.
#2 The output current must not exceed the maximum Pd and ASO.

# GUARANTEED OPERATING RANGES

Parameter	Symbol	Limits	Unit
Vcc for pre block	PreVcc	4.5~ 13.2	v
Vcc for power block	PowVcc	4.5~ PreVcc	v



## ELECTRICAL CHARACTERISTICS

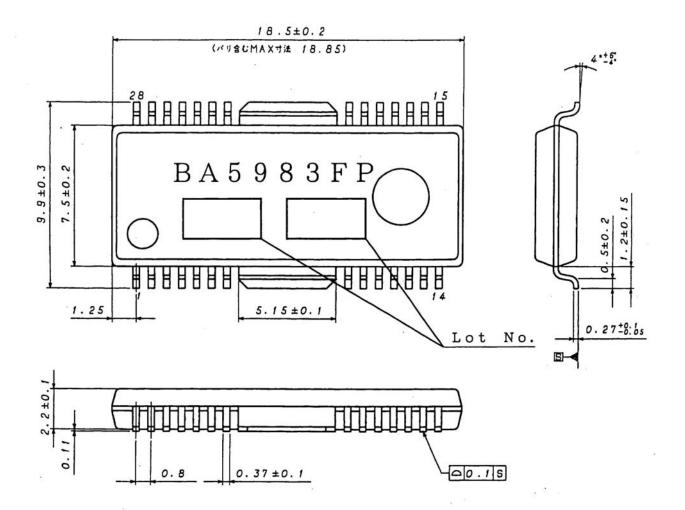
(Unless otherwise noted, Ta=25°C, PreVcc=8V,PowVcc1=5V,PowVcc2=8V,Valas =1.65V,RL=8Ω)

Parameter	Symbol	Min.	Тур.	Max.	UNIT	Conditions	Test circuit	
Quiescent current	IQ	-	20	32	mA	R L =00	Fig.5	
CH1-3 Standby Current	IQsti	-	6.2	13	mA	R L =00	Fig.5	
CH4 Standby Current	IQ <sub>6T2</sub>	-	16	26	mA	R L =∞	Fig.5	
All Channel Standby Current	IQeti	_	-	1	mA	R L =00	Fig.5	
<driver block=""></driver>								
Output offset voltage	VOOF	-70	-	70	mV		Fig.5	
Maximum output voltage 1	Vom1	3.6	4.0	-	V	CH1,2 VIN=VBLAS ± 1.65V	Fig.5	
Maximum output voltage 2	Vom2	5.4	6.0	-	V	CH3,4 VIN=VBLAS ± 1.65V	Fig.5	
Closed loop voltage gain 1	Gvcı	10	12	14	d B	CH1,2 VIN=VBLAS ± 0.5V	Fig.5	
Closed loop voltage gain 2	Gvc2	16	18	20	d B	CH3,4 VIN=VBLAS ± 0.5V	Fig.5	
Slew Rate	SRDRV	-	2	-	V	Input pulse 100kHz,2Vp-p	Fig.5	
Standby on voltage	VSTON	-	-	0.5	V		Fig.5	
Standby off voltage	VSTOFF	2.0	-	-	V		Fig.5	
Bias drop mute on voltage	VBM	-	-	0.7	V		Fig.5	
Bias drop mute off voltage	VBMbff         1.3         -         -         V         Fig.		Fig.5					
<pre amplifier="" operational=""></pre>								
Common mode input range	Vicm	0	-	6.8	v		Fig.5	
Input offset voltage	VOFOP	-6	0	6	mV		Fig.5	
Input bias current	Ibop	-	1	300	n A		Fig.5	
High level output voltage	VOHOP	7	7.8	1	V	VBIAS =4V	Fig.5	
Low level output voltage	VOLOP	-	-	0.3	v	VBLAS =4V	Fig.5	
Output sink current	Isı	1	1	-	mA	output to PreVcc by 500, Veias =4V	Fig.5	
Output source current	Iso .	300	500	-	μA	output to GND by $50$ Å, Values = 4V	Fig.5	
Slew rate	SROP	-	2	-	$V/\mu s$	Input pulse 100kHz,2Vp-p	Fig.5	

O This product is not designed for protection against radioactive rays.



## PACKAGE OUTLINES (mm)



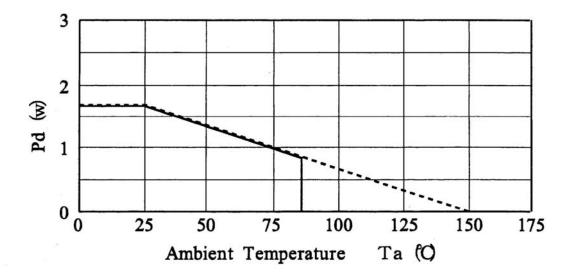
(UNITimm)

四番: EX140-5001-1





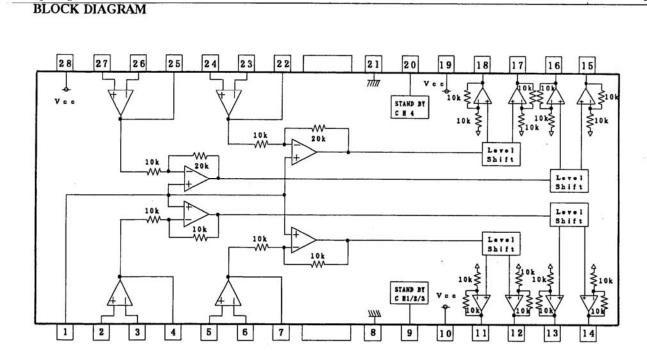
## POWER DISSIPATION / Electrical characteristic curves



Pd : power dissipation

\* On less than 3% (percentage occupied by copper foi),  $70 \times 70 \text{mm}^2$ , t=1.6mm glass epoxy mounting.

Figure 2



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Figure 3	•
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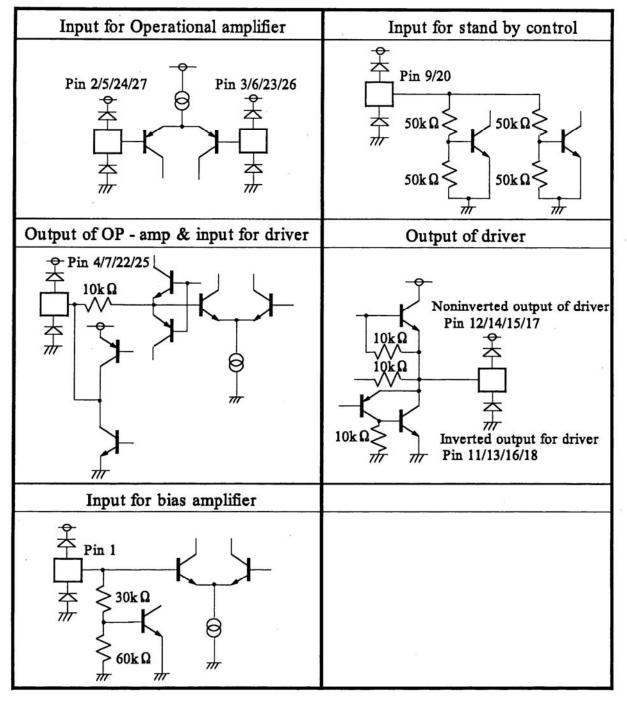
resistor unit :  $\Omega$ 

	Pin descr	iption			
NO	Symbol	Function	NO	Symbol	Function
1	BIAS IN	Input for Bias-amplifier	15	VO4( +)	Non inverted output of CH4
2	OPIN1(+)	Non inverting input for CH1 OP-AMP	16	VO4( -)	Inverted output of CH4
3	OPIN1(-)	Inverting input for CH1 OP-AMP	17	VO3( +)	Non inverted output of CH3
4	OPOUT1	Output for CH1 OP-AMP	18	VO3( -)	Inverted output of CH3
5	OPIN2(+)	Non inverting input for CH2 OP-AMP	19	PowVcc2	Vcc for CH3/4 power block
6	OPIN2(-)	Inverting input for CH2 OP-AMP	20	STBY2	Input for CH4 stand by control
7	OPOUT2	output for CH2 OP-AMP	21	GND	Substrate ground
8	GND	Substrate ground	22	OPOUT3	Output for CH3 OP-AMP
9	STBY1	Input for CH1/2/3 stand by control	23	OPIN3-)	Inverting input for CH3 OP-AMP
10	PowVcc1	Vcc for CH1/2 power block	24	OPIN3+)	Non inverting input for CH3 OP-AMP
11	VO2(-)	Inverted output of CH2	25	OPOUT4	Output for CH4 OP-AMP
12	VO2(+) -	Non inverted output of CH2	26	OPIN4(-)	Inverting input for CH4 OP-AMP
13	VO1(-)	Inverted output of CH1	27	OPIN4(+)	Non inverting input for CH4 OP-AMP
14	VO1(+)	Non inverted output of CH1	28	PreVcc	Vcc for pre block

notes) Symbol of + and - (output of drivers) means polarity to input pin. (For example if voltage of pin4 high,pin14 is high)



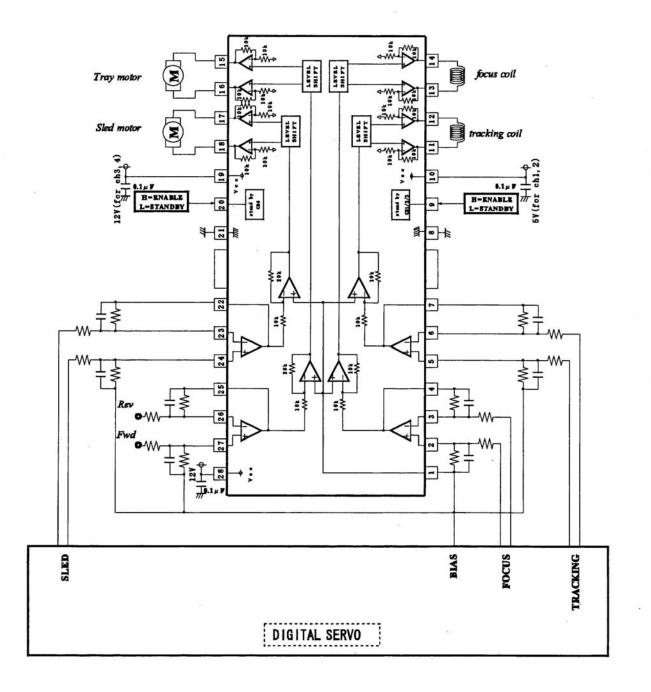
## EQUIVALENT CIRCUIT OF TERMINALS



resistor unit :  $\Omega$ 



#### **Application circuit**



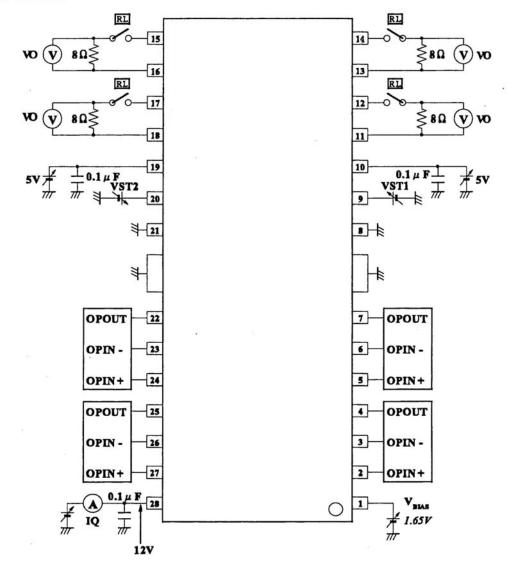
resistor unit :  $\Omega$ 

Figure 4



TEST CIRCUIT

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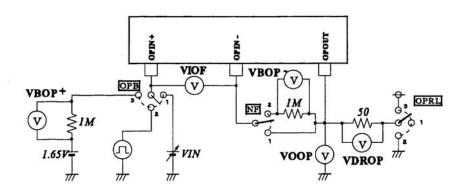




Figure 5

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#### Table of measuring circuit switches

1) Quiescent current or standby (VIN=V<sub>BIAS</sub>=1.65V, OPB  $\rightarrow$  1, RL  $\rightarrow$  OFF, NF  $\rightarrow$  1, OPRL  $\rightarrow$  1)

	Input		0	
Symbol	VST1	VST2	Conditions	Measuring point
IQ	5V	5V		IQ
IQST1	0V	5V		IQ
IQST2	5V	0V		IQ
IQST3	0 <b>V</b>	0 <b>V</b>		IQ

2) Driver block (OPB $\rightarrow$ 1,NF $\rightarrow$ 1,OPRL $\rightarrow$ 1, RL $\rightarrow$	ON)
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	SW		Input		$\frac{M}{M} \frac{M}{L} = \frac{1}{2}$		
Symbol	OPB	VIN	VST1	VST2	VBIAS	Condition	Measuring point
V001	1	1.65V	2.0V	2.0V	1.65V		VO (CH1,2)
V002	1	1.65V	2.0V	2.0V	1.65V		VO (CH3,4)
VOM1	1	± 1.65V	2.0V	2.0V	1.65V	VIN=0V or 3.3V	VO (CH1,2)
VOM2	1	± 1.65V	2.0V	2.0V	1.65V	VIN=0V or 3.3V	VO (CH3,4)
GVC1	1	± 0.5V	2.0V	2.0V	1.65V	VIN=1.15V or 2.15V	VO (CH1,2)
GVC2	1	± 0.5V	2.0V	2.0V	1.65V	VIN=1.15V or 2.15V	VO (CH3,4)
VSTON	1	3.0V	0.5V	0.5V	1.65V	Check output of driver is muted.	vo
VSTOFF	1	3.0V	2.0V	2.0V	1.65V	Check output of driver is active.	vo
VBMON	1	3.0V	0.5V	0.5V	0.5V	Check output of driver is muted.	vo
<b>/BMOFF</b>	1	3.0V	2.0V	2.0V	1.3V	Check output of driver is active.	vo
SRDRV	2	± 1V	2.0V	2.0V	1.65V	Input pulse 100kHz, *2V <sub>P</sub> -	vo

#### 3) Pre operational amplifier (VST1=VST2=2V,RL→ OFF)

		Switch	b	Inp	ut		
Symbol	OPB	NF	OPRL	VIN	VBIAS	Conditions	Measuring point
VOFOP	1	1	1	1.65V	1.65V		VIOF
VBOP	3	2	1	1.65V	1.65V		VBOP/1M Q
VOHOP	1	1	1	12V	6V	VBIAS=VCC/2	VOOP
VOLOP	1	1	1	0V	6V	VBIAS=VCC/2	VOOP
ISI	1	1	3	6V	6V	VBIAS=VCC/2	VDROP/50
ISO	1	1	2	6V	6V	VBIAS=VCC/2	VDROP/50
SROP	2	1	1	± 1.0V*	1.65V	Input pulse 100kHz, *2V <sub>PP</sub>	VOOP



#### Notes on use

- Thermal shut down circuit is built in. In case IC chip temperature rises to 175°C(typ), thermal shut down circuit operates and muted the output current. Next time IC chip temperature falls below 150°C(typ), the driver blocks start.
- 2. Bias pin (pin1) should be pulled up more than 1.3V. In case bias pin voltage is under 0.7V(typ.), output current is muted.
- 3. In case supply voltage falls below 3.8V( typ.), output current is muted. Next time supply voltage rises to 4.0V (typ.), the driver blocks start.
- 4. Mute operation is caused by thermal shut down, decrease of bias pin voltage or decrease of supply voltage. when mute is done, output voltage becomes internal reference voltage about PowVcc/2.
- 5. In case of one of the standby terminals turn into or open, correspondence channel circuit include opample is muted.
- 6. Both of the standby terminals low or open, all circuits shutdown (sleep mode) and all output pins become high impedance.
   In addition to threshold is 1.4V(typ.).
- 7. Supply voltage of PreVcc should be equal to or higher than PowVcc.
- 8. Take care the external resister value of OPamp. OPamp source current supplies to internal resister ( $10K \Omega$ ) as well as external resister.
- 9. Insert the by pass capacitor between Vcc pin and GND pin of IC as near as possible (approximately  $0.1\mu$ ).
- 10. Keep the GND pin voltage the lowest of all pins.
- 1 1. Heat dissipation fins are attached to the GND on the inside of the package. Make sure to connect these to the external GND.

	Notes
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